

2021 ASME EPPD Awards: Call for Nominations
Deadline: Sunday, September 19, 5 PM US Pacific Time

ASME's Electronic and Photonic Packaging Division (EPPD) is soliciting nominations for the following annual division awards:

1. EPPD Excellence in Mechanics Award
2. EPPD Women Engineer Award
3. EPPD Early Career Engineer Award
4. EPPD Student Member of the Year Award

Complete nominations should be submitted by email to SB Park (sbpark@binghamton.edu) and Koneru Ramakrishna (rama@ieee.org), Co-Chairs of the 2021 EPPD Awards Committee, and are due by **Sunday, September 19, 5 PM US Pacific Time**. Please include the words "**Nomination for EPPD Award: category**" in the subject line of your email. The following items are required in each nomination packet:

1. Nomination letter summarizing Nominee's qualifications and accomplishments.
2. Nominee's CV/Bio (50 pages or less).
3. Up to 3 letters of support. A minimum of two is required.
4. Nominee's ASME membership status and primary/secondary membership in EPPD.
Adding ASME membership numbers helps, but, not required.

The nominations will be evaluated by the EPPD Awards Committee, which consists of past senior members of EPPD and some of the past winners. The awards will be announced in prior to 2021 ASME InterPACK (October 26-28, 2021) and will be presented during the virtual event.

Details of the Awards follow.

1. Excellence in Mechanics Award

- a. The award is to recognize outstanding contributions to the applications of engineering mechanics in the field of electronic and/or photonic packaging, including stress analysis, reliability study, experimental methods and computational modeling.
- b. Emphasis will be placed on seminal work and product innovation and product development demonstrated through technical publications and patents.

2. EPPD Women Engineer Award

- a. The award is to recognize a woman engineer with significant technical achievements in the area of electronic and photonic packaging demonstrated through papers, patents, or product development.
- b. Contributions to EPPD activities (conferences, committees, Journal of Electronic Packaging, K16 etc.) are also important considerations.
- c. Nominee must be a primary or a secondary member of EPPD for at least last 1 year prior to nomination, or has demonstrated active involvement and outstanding contributions to InterPACK conference for the past 3 consecutive years.

3. EPPD Early Career Engineer Award

- a. The award is to recognize a young engineer with significant technical achievements in the career in the area of electronic and photonic packaging demonstrated through papers, patents, or product development.
- b. Contributions to EPPD activities (conferences, committees, Journal of Electronic Packaging, K16 etc.) are very important.
- c. Nominee must be a primary or a secondary member of EPPD for at least last 1 year prior to nomination, or has demonstrated active involvement and outstanding contributions to InterPACK conference for the past 3 consecutive years.
- d. Nominee must be **within 10 years since the last degree** received before December 31 of the year of the award.

4. EPPD Student Member of the Year Award

- a. The award is to recognize a current student who has excelled in research and has shown promise to be a strong contributor to the field of electronic and photonic packaging.
- b. Must demonstrate active participation in EPPD sponsored conferences such as InterPACK, IMECE, and ITherm
- c. Nominee must be enrolled as a full time undergraduate or graduate student conducting research in the area of electronic and photonic packaging.